

SFP-MRC-CU-100M

1000BASE-T Copper SFP Transceiver

PRODUCT FEATURES

Up to 1.25 Gb/s bi-directional data links

Hot-pluggable SFP footprint

Low power dissipation (1.05W typical)

Compact RJ-45 connector assembly

Fully metal enclosure, for lower EMI

RoHS compliant and lead-free

Single +3.3V power supply

1.25 Gigabit Ethernet over Cat 5 cable

Case operating temperature: Commercial: 0°C to +70°C

Industrial: -40°C to +85°C

PRODUCT DESCRIPTION

Cloudtron SFP-MRC-CU-100M 1000BASE-T Copper Small Form Pluggable (SFP) transceivers are based on the SFP Multi Source Agreement (MSA). They are compatible with the Gigabit Ethernet and 1000BASE-T standards as specified in IEEE Std 802.3. The 1000BASE-T physical layer IC (PHY) can be accessed via I2C, allowing access to all PHY settings and features.

The SFP-MRC-CU-100M uses the RX LOS pin for link indication, and 1000BASE-X autonegotiation should be disabled on the host system.

١. SFP to Host Connector Pin Out

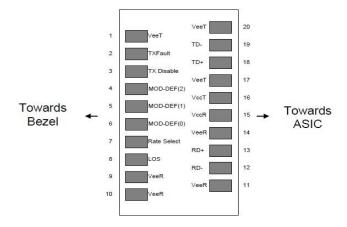


Figure 1. Diagram of host board connector block pin numbers and names



Pin	Symbol	Name/Description	Note
1	VEET	Transmitter Ground (Common with Receiver Ground)	1
2	TFAULT	Transmitter Fault. Not supported.	
3	TDIS	Transmitter Disable. Not supported.	
4	MOD_DEF(2)	Module Definition 2. Data line for Serial ID.	2
5	MOD_DEF(1)	Module Definition 1. Clock line for Serial ID.	2
6	MOD_DEF(0)	Module Definition 0. Grounded within the module.	2
7	Rate Select	No connection required	
8	LOS	Loss of Signal indication. Logic 0 indicates normal operation.	3
9	VEER	Receiver Ground (Common with Transmitter Ground)	1
10	VEER	Receiver Ground (Common with Transmitter Ground)	1
11	VEER	Receiver Ground (Common with Transmitter Ground)	1
12	RD-	Receiver Inverted DATA out. AC Coupled	
13	RD+	Receiver Non-inverted DATA out. AC Coupled	
14	VEER	Receiver Ground (Common with Transmitter Ground)	1
15	VCCR	Receiver Power Supply	
16	VCCT	Transmitter Power Supply	
17	VEET	Transmitter Ground (Common with Receiver Ground)	1
18	TD+	Transmitter Non-Inverted DATA in. AC Coupled.	
19	TD-	Transmitter Inverted DATA in. AC Coupled.	
20	VEET	Transmitter Ground (Common with Receiver Ground)	1

Note:

- 1. Circuit ground is connected to chassis ground
- Should be pulled up with 4.7k 10k Ohms on host board to a voltage between 2.0 V and 3.6 V. MOD_DEF(0) pulls line low to indicate module is plugged in.
- 3. LVTTL compatible with a maximum voltage of 2.5V.

II. +3.3V Volt Electrical Power Interface

The SFP-MRC-CU-100M has an input voltage range of 3.3 V +/- 5%. The 4V maximum voltage is not allowed for continuous operation.

+3.3 Volt Electrical Power Interface										
Parameter	Symbol	Min	Тур	Max	Unit	Note/Condition				
Supply Current	ls		320	375	mA	1.2W max power over full range of voltage and temperature. See caution note below				
Input Voltage	Vcc	3.13	3.3	3.47	V	Referenced to GND				
Maximum Voltage	Vmax			4	V					
Surge Current	Isurge			30	mA	Hot plug above steady state current. See caution note below				

Caution: Power consumption and surge current are higher than the specified values in the SFP MSA

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Low-Speed Signals III.

MOD_DEF(1) (SCL) and MOD_DEF(2) (SDA), are open drain CMOS signals (see section VII, "Serial Communication Protocol"). Both MOD_DEF(1) and MOD_DEF(2) must be pulled up to host_Vcc.

Low-Speed Signals, Electronic Characteristics										
Parameter Symbol Min		Max	Unit	Note/Condition						
SFP Output LOW	VOL	0	0.5	V	4.7k to 10k pull-up to host_Vcc, measured at host side of connector					
SFP Output HIGH	VOH	host_Vcc -0.5	host_Vcc + 0.3	V	4.7k to 10k pull-up to host_Vcc, measured at host side of connector					
SFP Input LOW	VIL	0	0.8	V	4.7k to 10k pull-up to Vcc, measured at SFP side of connector					
SFP Input HIGH	VIH	2	Vcc + 0.3	V	4.7k to 10k pull-up to Vcc, measured at SFP side of connector					

High-Speed Electrical Interface IV.

All high-speed signals are AC-coupled internally.

High-Speed Electrical Interface, Transmission Line-SFP										
Parameter	Symbol	Тур	Unit	Note/Condition						
Line Frequency	fL	125	MHz	5-level encoding, per IEEE 802.3						
Tx Output Impedance	Zout,TX	100	Ohm	Differential, for all frequencies between 1MHz and 125MHz						
Rx Input Impedance	t Impedance Zin,RX 100 Ohm		Ohm	Differential, for all frequencies between 1MHz and 125MHz						

High-Speed Electrical Interface, Host-SFP							
Parameter	Symbol	Min	Тур	Max	Unit	Note/Condition	
Single ended data input swing	Vinsing	250		1200	mV	Single ended	
Single ended data output swing	Voutsing	350		800	mV	Single ended	
Rise/Fall Time	Tr,Tf		175		psec	20%-80%	
Tx Input Impedance	Zin		50		Ohm	Single ended	
Rx Output Impedance	Zout		50		Ohm	Single ended	







General Specification ٧.

General										
Parameter	Symbol	Min	Тур	Max	Unit	Note/Condition				
Data Rate	BR	10		1000	Mb/sec	IEEE 802.3 compatible. See Notes 2 through to 4 below				
Cable Length	L			100	m	Category 5 UTP. BER				

Note:

- Clock tolerance is +/- 50 ppm 1.
- By default, the SFP-MRC-CU-100M is a full duplex device in preferred master mode 2.
- Automatic crossover detection is enabled. External crossover cable is not required
- 4. SFP-MRC-CU-100M does not support SGMII. With a SERDES the module will operate at 1000BASE-T only

Environmental Specification VI.

Environmental Specification							
Parameter	Symbol	Min	Max	Unit	Notes/Conditions		
Case Operating Temperature	Tcase	0	70	°C	SFP-MRC-CU-100M		
Case Operating Temperature		-40	85	°C	SFP-MRC-CU-100M-I		
Storage Temperature	Tsto	-40	85	°C	Ambient temperature		

VII. Serial Communication Protocol

SFP-MRC-CU-100M support the 2-wire serial communication protocol outlined in the SFP MSA. It uses use an Atmel AT24C02B 256 byte EEPROM with an address of A0h.

Serial Bus Timing Requirements								
Parameter	Min	Max	Unit					
I2C Clock Rate	0	100,000	Hz					

Mechanical Specification (Unit: mm) VIII.

